



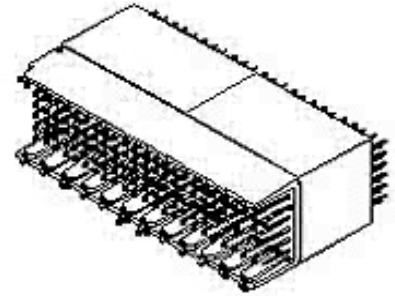
Part Number : [737690109](#)

Product Description : HDM Board-to-Board Stacking Header, High Rise Vertical, Press-Fit, Open End Option, 72 Circuits, Stack Height 15.05mm

Series Number : 73769

Status : Active

Product Category : Backplane Connectors



Documents and Resources

Drawings

[737690109 sd.pdf](#)


Specifications

[AS-73642-9998-001.pdf](#)

[PS-73780-999-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration

- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	Backplane Connectors
Series	73769
Description	HDM Board-to-Board Stacking Header, High Rise Vertical, Press-Fit, Open End Option, 72 Circuits, Stack Height 15.05mm
Application	Backplane, Mezzanine
Component Type	PCB Header
Product Name	HDM
UPC	884982748965

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	72
Voltage - Maximum	100V AC

Physical

Circuits (Loaded)	72
Circuits (maximum)	72
Color - Resin	Black
Durability (mating cycles max)	200

First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	No
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	12.780/g
Number of Columns	12
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	No
PCB Thickness - Recommended	2.50mm
PC Tail Length	3.50mm
Pitch - Mating Interface	2.00mm
Plating min - Mating	0.762µm
Plating min - Termination	0.381µm
Polarized to PCB	No
Stackable	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole - Compliant Pin

Solder Process Data

Lead-Free Process Capability	N/A
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Mates With / Use With

Mates with Part(s)

Description	Part Number
HDM Daughtercard Receptacles	<u>73632</u>
HDM Vertical Daughtercard	<u>73780</u>

Receptacles	
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Application Tooling

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